±75mA

0.9pA/√Hz

-62dBc

68ns

100ns



LMH6642/LMH6643/LMH6644

Low Power, 130MHz, 75mA Rail-to-Rail Output Amplifiers

General Description

The LMH664X family true single supply voltage feedback amplifiers offer high speed (130MHz), low distortion (-62dBc), and exceptionally high output current (approximately 75mA) at low cost and with reduced power consumption when compared against existing devices with similar performance.

Input common mode voltage range extends to 0.5V below V - and 1V from V+. Output voltage range extends to within 40mV of either supply rail, allowing wide dynamic range especially desirable in low voltage applications. The output stage is capable of approximately 75mA in order to drive heavy loads. Fast output Slew Rate (130V/µs) ensures large peak-to-peak output swings can be maintained even at higher speeds, resulting in exceptional full power bandwidth of 40MHz with a 3V supply. These characteristics, along with low cost, are ideal features for a multitude of industrial and commercial applications.

Careful attention has been paid to ensure device stability under all operating voltages and modes. The result is a very well behaved frequency response characteristic (0.1dB gain flatness up the 12MHz under 150 Ω load and A_V = +2) with minimal peaking (typically 2dB maximum) for any gain setting and under both heavy and light loads. This along with fast settling time (68ns) and low distortion allows the device to operate well in ADC buffer, and high frequency filter applications as well as other applications.

This device family offers professional quality video performance with low DG (0.01%) and DP (0.01°) characteristics. Differential Gain and Differential Phase characteristics are also well maintained under heavy loads (150 Ω) and throughout the output voltage range. The LMH664X family is offered in single (LMH6642), dual (LMH6643), and quad (LMH6644) options. See ordering information for packages offered.

Closed Loop Gain vs. Frequency for Various Gain



Features

 $(V_s = \pm 5V, T_A = 25^{\circ}C, R_I = 2k\Omega, A_V = +1$. Typical values unless specified)

- -3dB BW (A_V = +1) -130MHz 2.7V to 12.8V -Supply voltage range
- Slew rate (*Note 8*), $(A_v = -1)$ 130V/µs 2.7mA/amp
- Supply current (no load) +115mA/-145mA
- Output short circuit current
- Linear output current
- 0.5V beyond V-, 1V from V+ Input common mode volt.
- Output voltage swing 40mV from rails 17nV/√Hz
- Input voltage noise (100kHz)
- -Input current noise (100kHz)
- THD (5MHz, $R_1 = 2k\Omega$, $V_0 = 2V_{PP}$, $A_V = +2$)
- Settling time
- Fully characterized for 3V, 5V, and ±5V
- Overdrive recovery
- Output short circuit protected (Note 11)
- No output phase reversal with CMVR exceeded

Applications

- Active filters
- CD/DVD ROM -
- . ADC buffer amp
- Portable video
- Current sense buffer



Large Signal Frequency Response

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.

2KV (<i>Note 2</i>)
1000V (<i>Note 13</i>)
±2.5V
(Note 3), (Note 11)
13.5V
V+ +0.8V, V0.8V
±10mA
–65°C to +150°C
+150°C

3V Electrical Characteristics

Soldering Information Infrared or Convection Reflow(20 sec) 235°C Wave Soldering Lead Temp.(10 sec) 260°C

Operating Ratings (Note 1)

Supply Voltage (V+ – V-)	2.7V to 12.8V
Junction Temperature Range (Note 4)	$-40^{\circ}C$ to $+85^{\circ}C$
Package Thermal Resistance (<i>Note 4</i>) (θ_{JA})	
5-Pin SOT-23	265°C/W
8-Pin SOIC	190°C/W
8-Pin MSOP	235°C/W
14-Pin SOIC	145°C/W
14- Pin TSSOP	155°C/W

Unless otherwise specified, all limits guaranteed for at $T_J = 25^{\circ}C$, $V^+ = 3V$, $V^- = 0V$, $V_{CM} = V_O = V^+/2$, V_{ID} (input differential voltage) as noted (where applicable) and $R_I = 2k\Omega$ to $V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (<i>Note 6</i>)	Typ (<i>Note 5</i>)	Max (<i>Note 6</i>)	Units	
BW	–3dB BW	$A_{V} = +1, V_{OUT} = 200 m V_{PP}$	80	115			
		$A_V = +2, -1, V_{OUT} = 200 mV_{PP}$		46		MHZ	
BW _{0.1dB}	0.1dB Gain Flatness	$A_{V} = +2, R_{I} = 150\Omega$ to V+/2,		19		MHz	
		$R_{L} = 402\Omega, V_{OUT} = 200 mV_{PP}$					
PBW	Full Power Bandwidth	$A_V = +1, -1$ dB, $V_{OUT} = 1V_{PP}$		40		MHz	
e _n	Input-Referred Voltage Noise	f = 100kHz		17		nV/√Hz	
		f = 1kHz		48			
i _n	Input-Referred Current Noise	f = 100kHz		0.90		A 1/11-	
		f = 1kHz		3.3		ра/√нг	
THD	Total Harmonic Distortion	$f = 5MHz, V_0 = 2V_{PP}, A_V = -1,$		-48		dPo	
		R_{L} = 100Ω to V+/2				UDC	
DG	Differential Gain	$V_{CM} = 1V$, NTSC, $A_V = +2$		0.17			
		R_L =150 Ω to V+/2				%	
		$R_L = 1k\Omega$ to V+/2		0.03			
DP	Differential Phase	V _{CM} = 1V, NTSC, A _V = +2		0.05			
		R_L =150 Ω to V+/2				deg	
		$R_L = 1k\Omega$ to V+/2		0.03			
CT Rej.	Cross-Talk Rejection	f = 5MHz, Receiver:		47		dB	
		$R_{f} = R_{g} = 510\Omega, A_{V} = +2$					
T _s	Settling Time	V _O = 2V _{PP} , ±0.1%, 8pF Load,		68		ns	
		$V_{S} = 5V$					
SR	Slew Rate (Note 8)	$A_V = -1, V_I = 2V_{PP}$	90	120		V/µs	
V _{os}	Input Offset Voltage	For LMH6642 and LMH6644		±1	±5		
					±7	mV	
		For LMH6643		±1	±3.4		
					±7		
IC V _{OS}	Input Offset Average Drift			±5		μν/°C	
I _В	Input Bias Current	(Note /)		-1.50	-2.60 - 3.25	μA	
I _{OS}	Input Offset Current			20	800 1000	nA	
RIN	Common Mode Input Resistance			3		МО	
111		1	I	-	1		

Symbol	Parameter	Conditions	Min (<i>Note 6</i>)	Typ (<i>Note 5</i>)	Max (<i>Note 6</i>)	Units
C _{IN}	Common Mode Input Capacitance			2		pF
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50dB		-0.5	-0.2 - 0.1	V
			1.8 1.6	2.0		v
CMRR	Common Mode Rejection Ratio	V _{CM} Stepped from 0V to 1.5V	72	95		dB
A _{VOL}	Large Signal Voltage Gain	$V_{O} = 0.5V$ to 2.5V $R_{L} = 2k\Omega$ to V+/2	80 75	96		dP
		$V_{O} = 0.5V$ to 2.5V 74 $R_{L} = 150\Omega$ to V+/2 70	74 70	82		uВ
Vo	Output Swing	$R_L = 2k\Omega$ to V+/2, $V_{ID} = 200mV$	2.90	2.98		M
	High	R_{L} = 150 Ω to V+/2, V _{ID} = 200mV	2.80	2.93		v
	Output Swing	$R_L = 2k\Omega$ to V+/2, $V_{ID} = -200mV$		25	75	
	Low	$R_{L} = 150\Omega$ to V+/2, $V_{ID} = -200$ mV		75	150	mv
I _{SC}	Output Short Circuit Current	Sourcing to V+/2 V _{ID} = 200mV (<i>Note 10</i>)	50 35	95		
		Sinking to V+/2 V _{ID} = -200mV (<i>Note 10</i>)	55 40	110		MA
I _{OUT}	Output Current	V _{OUT} = 0.5V from either supply		±65		mA
+PSRR	Positive Power Supply Rejection Ratio	$V^+ = 3.0V$ to 3.5V, $V_{CM} = 1.5V$	75	85		dB
I _S	Supply Current (per channel)	No Load		2.70	4.00 4.50	mA

5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for at $T_J = 25^{\circ}C$, $V^+ = 5V$, $V^- = 0V$, $V_{CM} = V_O = V^+/2$, V_{ID} (input differential voltage) as noted (where applicable) and $R_L = 2k\Omega$ to $V^+/2$. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min (<i>Note 6</i>)	Typ (<i>Note 5</i>)	Max (<i>Note 6</i>)	Units
BW	–3dB BW	$A_{V} = +1, V_{OUT} = 200 m V_{PP}$	90	120		
		$A_V = +2, -1, V_{OUT} = 200 m V_{PP}$		46		IVIHZ
BW _{0.1dB}	0.1dB Gain Flatness	$A_V = +2$, $R_L = 150\Omega$ to V+/2,		15		MHz
		$R_f = 402\Omega, V_{OUT} = 200mV_{PP}$				
PBW	Full Power Bandwidth	$A_V = +1, -1dB, V_{OUT} = 2V_{PP}$		22		MHz
e _n	Input-Referred Voltage Noise	f = 100kHz		17		VU/11-
		f = 1kHz		48		− nV/√HZ
i _n	Input-Referred Current Noise	f = 100kHz		0.90		~ ^ / / I =
		f = 1kHz		3.3		pav₄ nz
THD	Total Harmonic Distortion	$f = 5MHz, V_0 = 2V_{PP}, A_V = +2$		-60		dBc
DG	Differential Gain	NTSC, $A_V = +2$		0.16		
		R_L =150 Ω to V+/2				%
		$R_L = 1k\Omega$ to V+/2		0.05		
DP	Differential Phase	NTSC, $A_V = +2$		0.05		
		$R_L = 150\Omega$ to V+/2				deg
		$R_L = 1k\Omega$ to V+/2		0.01		
CT Rej.	Cross-Talk Rejection	f = 5MHz, Receiver:		47		dD
		$R_{f} = R_{g} = 510\Omega, A_{V} = +2$				uВ

Symbol	Parameter	Conditions	Min (<i>Note 6</i>)	Typ (<i>Note 5</i>)	Max (<i>Note 6</i>)	Units
T _s	Settling Time	V _O = 2V _{PP} , ±0.1%, 8pF Load		68		ns
SR	Slew Rate (Note 8)	$A_V = -1, V_I = 2V_{PP}$	95	125		V/µs
V _{OS}	Input Offset Voltage	For LMH6642 and LMH6644		±1	±5 ±7	
		For LMH6643		±1	±3.4 ±7	
TC V _{OS}	Input Offset Average Drift	(Note 12)		±5		μV/°C
I _B	Input Bias Current	(Note 7)		-1.70	-2.60 -3.25	μΑ
I _{OS}	Input Offset Current			20	800 1000	nA
R _{IN}	Common Mode Input Resistance			3		MΩ
C _{IN}	Common Mode Input Capacitance			2		pF
CMVR Input Co Range	Input Common-Mode Voltage Range	CMRR ≥ 50dB		-0.5	-0.2 - 0.1	N
			3.8 3.6	4.0		
CMRR	Common Mode Rejection Ratio	V _{CM} Stepped from 0V to 3.5V	72	95		dB
A _{VOL}	Large Signal Voltage Gain	$V_{O} = 0.5V$ to 4.50V R _L = 2k Ω to V+/2	86 82	98		
		$V_{O} = 0.5V$ to 4.25V R _L = 150 Ω to V+/2	76 72	82		
Vo	Output Swing	$R_{I} = 2k\Omega$ to V+/2, $V_{ID} = 200mV$	4.90	4.98		
	High	$R_{\rm L} = 150\Omega$ to V ⁺ /2, V _{ID} = 200mV	4.65	4.90		
	Output Swing	$R_{\rm L} = 2k\Omega$ to V+/2, $V_{\rm ID} = -200$ mV		25	100	
	Low	$R_{\rm I} = 150\Omega$ to V+/2, $V_{\rm ID} = -200$ mV		100	150	mV
I _{sc}	Output Short Circuit Current	Sourcing to V+/2	55	115		
		V _{ID} = 200mV (<i>Note 10</i>)	40			mA
		Sinking to V+/2	70	140		
		V _{ID} = -200mV (<i>Note 10</i>)	55			
I _{OUT}	Output Current	$V_{O} = 0.5V$ from either supply		±70		mA
+PSRR	Positive Power Supply Rejection Ratio	V+ = 4.0V to 6V	79	90		dB
I _S	Supply Current (per channel)	No Load		2.70	4.25 5.00	mA

±5V Electrical Characteristics

Unless otherwise specified, all limits guaranteed for at $T_J = 25^{\circ}C$, $V^+ = 5V$, $V^- = -5V$, $V_{CM} = V_O = 0V$, V_{ID} (input differential voltage) as noted (where applicable) and $R_L = 2k\Omega$ to ground. **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
			(Note 6)	(Note 5)	(<i>Note 6</i>)	
BW	–3dB BW	$A_V = +1, V_{OUT} = 200 mV_{PP}$	95	130		M⊔⊸
		$A_V = +2, -1, V_{OUT} = 200 m V_{PP}$		46		
BW _{0.1dB}	0.1dB Gain Flatness	$A_V = +2, R_L = 150\Omega$ to V+/2,		12		MHz
		R_f = 806 Ω , V_{OUT} = 200m V_{PP}				
PBW	Full Power Bandwidth	$A_V = +1, -1dB, V_{OUT} = 2V_{PP}$		24		MHz
e _n	Input-Referred Voltage Noise	f = 100kHz		17		$-\pi u/U=$
		f = 1kHz		48		∏V/V HZ

LMH6642/LMH6643/LMH6644

Symbol	Parameter	Conditions	Min (<i>Note 6</i>)	Typ (<i>Note 5</i>)	Max (<i>Note 6</i>)	Units
i _n	Input-Referred Current Noise	f = 100kHz		0.90		A (/ 11
		f = 1kHz		3.3		pA/√Hz
THD	Total Harmonic Distortion	$f = 5MHz, V_0 = 2V_{PP}, A_V = +2$		-62		dBc
DG	Differential Gain	NTSC, $A_V = +2$		0.15		
		R_L = 150 Ω to V+/2				%
		$R_L = 1k\Omega$ to V+/2		0.01		
DP	Differential Phase	NTSC, $A_V = +2$		0.04		
		R_L = 150 Ω to V+/2				deg
		$R_L = 1k\Omega$ to V+/2		0.01		
CT Rej.	Cross-Talk Rejection	f = 5MHz, Receiver:		47		dB
		$R_f = R_g = 510\Omega, A_V = +2$				<u>ub</u>
т _s	Settling Time	$V_{O} = 2V_{PP}, \pm 0.1\%, 8pF Load,$ $V_{S} = 5V$		68		ns
SR	Slew Rate (Note 8)	$A_{V} = -1, V_{I} = 2V_{PP}$	100	135		V/µs
V _{OS}	Input Offset Voltage	For LMH6642 and LMH6644		±1	±5 ±7	
		For LMH6643		±1	±3.4 ±7	mv
TC V _{OS}	Input Offset Average Drift	(Note 12)		±5		µV/°C
Ι _Β	Input Bias Current	(Note 7)		-1.60	-2.60 -3.25	μΑ
I _{OS}	Input Offset Current			20	800 1000	nA
R _{IN}	Common Mode Input Resistance			3		MΩ
C _{IN}	Common Mode Input Capacitance			2		pF
CMVR	Input Common-Mode Voltage Range	CMRR ≥ 50dB		-5.5	-5.2 -5.1	V
			3.8 3.6	4.0		V
CMRR	Common Mode Rejection Ratio	V _{CM} Stepped from –5V to 3.5V	74	95		dB
A _{VOL}	Large Signal Voltage Gain	$V_0 = -4.5V$ to 4.5V,	88	96		
		$R_L = 2k\Omega$	84			٩D
		$V_{O} = -4.0V$ to 4.0V, $R_{L} = 150\Omega$	78 74	82		uВ
Vo	Output Swing	$R_{L} = 2k\Omega, V_{ID} = 200mV$	4.90	4.96		
	High	$R_{\rm I} = 150\Omega, V_{\rm ID} = 200 {\rm mV}$	4.65	4.80		V
	Output Swing	$R_{i} = 2k\Omega, V_{iD} = -200mV$		-4.96	-4.90	
	Low	$B_{\rm r} = 150\Omega, V_{\rm rp} = -200 \text{mV}$		-4.80	-4.65	V
	Output Short Circuit Current	Sourcing to Ground	60	115		
50		V _{ID} = 200mV (<i>Note 10</i>)	35	-		
		Sinking to Ground	85	145		mA
		V _{ID} = -200mV (<i>Note 10</i>)	65			
I _{OUT}	Output Current	V _O = 0.5V from either supply	±75			mA
PSRR	Power Supply Rejection Ratio	(V+, V−) = (4.5V, −4.5V) to (5.5V, −5.5V)	78	90		dB
I _S	Supply Current (per channel)	No Load		2.70	4.50 5.50	mA

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Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not guaranteed. For guaranteed specifications and the test conditions, see the Electrical Characteristics.

Note 2: Human body model, $1.5k\Omega$ in series with 100pF.

Note 3: Applies to both single-supply and split-supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C.

Note 4: The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} , and T_{A} . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A)/|\theta_{JA}|$. All numbers apply for packages soldered directly onto a PC board.

Note 5: Typical values represent the most likely parametric norm.

Note 6: All limits are guaranteed by testing or statistical analysis.

Note 7: Positive current corresponds to current flowing into the device.

Note 8: Slew rate is the average of the rising and falling slew rates.

Note 9: Machine Model, 0Ω in series with 200pF.

Note 10: Short circuit test is a momentary test. See Note 11.

Note 11: Output short circuit duration is infinite for $V_S < 6V$ at room temperature and below. For $V_S > 6V$, allowable short circuit duration is 1.5ms. **Note 12:** Offset voltage average drift determined by dividing the change in V_{OS} at temperature extremes by the total temperature change.

Note 13: CDM: Charge Device Model

Connection Diagrams



Top View





Top View



LMH6642/LMH6643/LMH6644

Typical Performance Characteristics At specified.

$T_J = 25^{\circ}C, V^+ = +5, V^- = -5V, R_F = R_F$	$L = 2k\Omega$. Unless otherwise
---	-----------------------------------



Closed Loop Gain vs. Frequency for Various Gain



20018551





Closed Loop Gain vs. Frequency for Various Supplies



Closed Loop Frequency Response for Various Temperature



Closed Loop Frequency Response for Various Temperature









Open Loop Gain/Phase for Various Temperature



HD3 (dBc) vs. Output Swing





























Output Sinking Saturation Voltage vs. IOUT





















PSRR vs. Frequency















V_{OS} vs. V_S (for 3 Representative Units)















Small Signal Step Response



Small Signal Step Response















Large Signal Step Response



20018560

Small Signal Step Response







Application Information

CIRCUIT DESCRIPTION

The LMH664X family is based on National Semiconductor's proprietary VIP10 dielectrically isolated bipolar process.

This device family architecture features the following:

- Complimentary bipolar devices with exceptionally high f_t (~8GHz) even under low supply voltage (2.7V) and low bias current.
- A class A-B "turn-around" stage with improved noise, offset, and reduced power dissipation compared to similar speed devices (patent pending).
- Common Emitter push-push output stage capable of 75mA output current (at 0.5V from the supply rails) while consuming only 2.7mA of total supply current per channel. This architecture allows output to reach within milli-volts of either supply rail.
- Consistent performance over the entire operating supply voltage range with little variation for the most important specifications (e.g. BW, SR, I_{OUT}, etc.)
- Significant power saving (~40%) compared to competitive devices on the market with similar performance.

Application Hints

This Op Amp family is a drop-in replacement for the AD805X family of high speed Op Amps in most applications. In addition, the LMH664X will typically save about 40% on power dissipation, due to lower supply current, when compared to competition. All AD805X family's guaranteed parameters are included in the list of LMH664X guaranteed specifications in order to ensure equal or better level of performance. However, as in most high performance parts, due to subtleties of applications, it is strongly recommended that the performance of the part to be evaluated is tested under actual operating conditions to ensure full compliance to all specifications.

With 3V supplies and a common mode input voltage range that extends 0.5V below V⁻, the LMH664X find applications in low voltage/low power applications. Even with 3V supplies, the –3dB BW (@ $A_V = +1$) is typically 115MHz with a tested limit of 80MHz. Production testing guarantees that process variations with not compromise speed. High frequency response is exceptionally stable confining the typical –3dB BW over the industrial temperature range to ±2.5%.

As can be seen from the typical performance plots, the LMH664X output current capability (~75mA) is enhanced compared to AD805X. This enhancement, increases the output load range, adding to the LMH664X's versatility.

Because of the LMH664X's high output current capability attention should be given to device junction temperature in order not to exceed the Absolute Maximum Rating.

This device family was designed to avoid output phase reversal. With input overdrive, the output is kept near supply rail (or as closed to it as mandated by the closed loop gain setting and the input voltage). See *Figure 1*:



FIGURE 1. Input and Output Shown with CMVR Exceeded

However, if the input voltage range of -0.5V to 1V from V⁺ is exceeded by more than a diode drop, the internal ESD protection diodes will start to conduct. The current in the diodes should be kept at or below 10mA.

Output overdrive recovery time is less than 100ns as can be seen from *Figure 2* plot:



FIGURE 2. Overload Recovery Waveform

INPUT AND OUTPUT TOPOLOGY

All input / output pins are protected against excessive voltages by ESD diodes connected to V+ and V- rails (see Figure 3). These diodes start conducting when the input / output pin voltage approaches 1V_{he} beyond V⁺ or V⁻ to protect against over voltage. These diodes are normally reverse biased. Further protection of the inputs is provided by the two resistors (R in Figure 3), in conjunction with the string of anti-parallel diodes connected between both bases of the input stage. The combination of these resistors and diodes reduces excessive differential input voltages approaching 2V_{be}. The most common situation when this occurs is when the device is used as a comparator (or with little or no feedback) and the device inputs no longer follow each other. In such a case, the diodes may conduct. As a consequence, input current increases and the differential input voltage is clamped. It is important to make sure that the subsequent current flow through the device input pins does not violate the Absolute Maximum Ratings of the device. To limit the current through this protection circuit, extra series resistors can be placed. Together with the built-in series resistors of several hundred ohms, these external resistors can limit the input current to a safe number (i.e. < 10mA). Be aware that these input series resistors may impact the switching speed of the device and could slow down the device.



FIGURE 3. Input Equivalent Circuit

SINGLE SUPPLY, LOW POWER PHOTODIODE AMPLIFIER

The circuit shown in *Figure 4* is used to amplify the current from a photo-diode into a voltage output. In this circuit, the emphasis is on achieving high bandwidth and the transimpedance gain setting is kept relatively low. Because of its high slew rate limit and high speed, the LMH664X family lends itself well to such an application.

This circuit achieves approximately 1V/mA of transimpedance gain and capable of handling up to $1mA_{pp}$ from the photodiode. Q1, in a common base configuration, isolates the high capacitance of the photodiode (C_d) from the Op Amp input in order to maximize speed. Input is AC coupled through C1 to ease biasing and allow single supply operation. With 5V single supply, the device input/output is shifted to near half supply using a voltage divider from V_{CC} . Note that Q1 collector does not have any voltage swing and the Miller effect is minimized. D1, tied to Q1 base, is for temperature compensation of Q1's bias point. Q1 collector current was set to be large enough to handle the peak-to-peak photodiode excitation and not too large to shift the U1 output too far from mid-supply. No matter how low an R_f is selected, there is a need for C_f in order to stabilize the circuit. The reason for this is that the Op Amp input capacitance and Q1 equivalent collector capacitance together (C_{IN}) will cause additional phase shift to the signal fed back to the inverting node. Cf will function as a zero in the feedback path counter-acting the effect of the C_{IN} and acting to stabilized the circuit. By proper selection of C_f such that the Op Amp open loop gain is equal to the inverse of the feedback factor at that frequency, the response is optimized with a theoretical 45° phase margin.

$$C_{F} = \sim SQRT\left[(C_{IN})/(2\pi \cdot GBWP \cdot R_{F})\right]$$
(1)

where GBWP is the Gain Bandwidth Product of the Op Amp Optimized as such, the I-V converter will have a theoretical pole, f_n , at:

$$f_{P} = SQRT[GBWP/(2\pi R_{F} \cdot C_{IN})]$$
⁽²⁾

With Op Amp input capacitance of 3pF and an estimate for Q1 output capacitance of about 3pF as well, $C_{IN} = 6pF$. From the typical performance plots, LMH6642/6643 family GBWP is approximately 57MHz. Therefore, with $R_f = 1k$, from Equation 1 and 2 above.

$$C_f = \sim 4.1 \text{pF}$$
, and $f_p = 39 \text{MHz}$



FIGURE 4. Single Supply Photodiode I-V Converter

For this example, optimum C_f was empirically determined to be around 5pF. This time domain response is shown in *Figure 5* below showing about 9ns rise/fall times, corresponding to about 39MHz for f_p. The overall supply current from the +5V supply is around 5mA with no load.



FIGURE 5. Converter Step Response (1V_{PP}, 20 ns/DIV)

PRINTED CIRCUIT BOARD LAYOUT AND COMPONENT VALUES SECTION

Generally, a good high frequency layout will keep power supply and ground traces away from the inverting input and output pins. Parasitic capacitances on these nodes to ground will cause frequency response peaking and possible circuit oscillations (see Application Note OA-15 for more information). National Semiconductor suggests the following evaluation boards as a guide for high frequency layout and as an aid in device testing and characterization:

Device	Package	Evaluation Board PN
LMH6642MF	5-Pin SOT-23	LMH730216
LMH6642MA	8-Pin SOIC	LMH730227
LMH6643MA	8-Pin SOIC	LMH730036
LMH6643MM	8-Pin MSOP	LMH730123
LMH6644MA	14-Pin SOIC	LMH730231
LMH6644MT	14-Pin TSSOP	LMH730131

Another important parameter in working with high speed/high performance amplifiers, is the component values selection. Choosing external resistors that are large in value will effect the closed loop behavior of the stage because of the interaction of these resistors with parasitic capacitances. These capacitors could be inherent to the device or a by-product of the board layout and component placement. Either way, keeping the resistor values lower, will diminish this interaction to a large extent. On the other hand, choosing very low value resistors could load down nodes and will contribute to higher overall power dissipation.

Package	Part Number	Package Marking	Transport Media	NSC Drawing		
E Din COT 02	LMH6642MF	4644	1k Units Tape and Reel			
5-PIII 501-25	LMH6642MFX	A04A	3k Units Tape and Reel	- INIFUSA		
	LMH6642MA		95 Units/Rail			
	LMH6642MAX LMH6642MA 2.5k Un		2.5k Units Tape and Reel	MORA		
0-PIII 3010	LMH6643MA		LMH6643MA 95 Units/Rail		95 Units/Rail	
	LMH6643MAX		2.5k Units Tape and Reel			
	LMH6643MM	A.C.E.A.	1k Units Tape and Reel	MUAORA		
0-FIII MISOF	LMH6643MMX	ACOA	3.5k Units Tape and Reel			
	LMH6644MA		55 units/Rail	N4140		
14-PIII 3010	LMH6644MAX		2.5k Units Tape and Reel	IVIT4A		
	LMH6644MT		94 Units/Rail	MTC14		
14-21111550	LMH6644MTX		2.5k Units Tape and Reel			

Ordering Information







14-Pin TSSOP NS Package Number MTC14

LMH6642/LMH6643/LMH6644

Notes

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